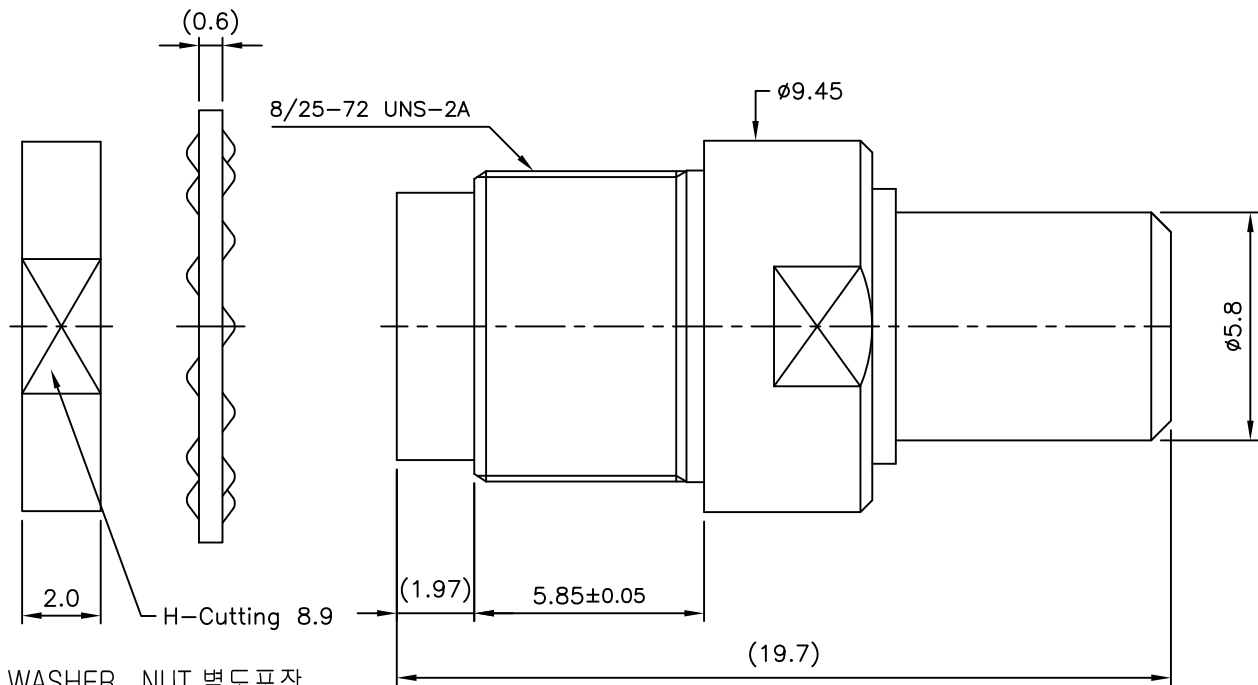


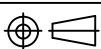
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2024.06.27.



14	NUT	1	MBsBD C3604BD-F	Suco Plate	DNT00096-5/2
13	WASHER	1	SUS	Passivate	DWA00133-5/1
12	RESISTOR	1	—	—	DRE00362-N/1
11	E형 멈춤링	1	SUS	Passivate	DSR01128-5/1
10	SPRING	1	SUS	Passivate	DSR01129-5/1
9	PLATE SPRING	1	BeCu C17300	Gold Plate	DPS00002-5/1
8	COVER	1	MBsBD C3604BD-F	Gold Plate	DCO00135-5/1
7	INSULATOR	1	TEFLON		DIN03400-N/2
6	INSULATOR	1	TEFLON		DIN02820-N/1
5	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT04439-5/1
4	COVER	1	MBsBD C3604BD-F	Gold Plate	DIB00026-5/1
3	CONTACT	1	BeCu C17300	Gold Plate (1.27μm)	DCT03747-5/2
2	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04214-5/4
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04213-5/3
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

ELECTRICAL SPECIFICATIONS		
1	FREQUENCY RANGE	DC ~ 6GHz
2	IMPEDANCE	50Ω NOMINAL
3	V.S.W.R (Max)	1.20 @ 6GHz
		1.15 @ 5.3~5.9GHz
4	POWER	2 Watt

TOLERANCE	Decimal ±0.2	DATE 2024. 06. 27.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017 KJ COMTECH CO.,LTD.		
	Angle ±1°	APPROVED BY					
	MATERIAL _____	CHECKED BY			TITLE BMA50 JB TERMINATION		
DRAWN BY S.H.KIM							
FINISH _____	SCALE 5/1		UNIT mm		A4	DWG NO. TM00213-7/1	
						REVISION I R	SHEET 1 of 1



A4